

### Surface Mount Schottky Barrier Rectifier

Reverse Voltage - 20 to 200V

Forward Current - 3.0A

### FEATURES

- Metal silicon junction, majority carrier conduction
- For surface mounted applications
- Low power loss, high efficiency
- High forward surge current capability
- For use in low voltage, high frequency inverters, free wheeling, and polarity protection applications

### PINNING

PIN	DESCRIPTION
1	Cathode
2	Anode



Simplified outline SMBF and symbol

### MECHANICAL DATA

- Case: SMBF
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 57mg / 0.002oz

### Absolute Maximum Ratings and Electrical characteristics

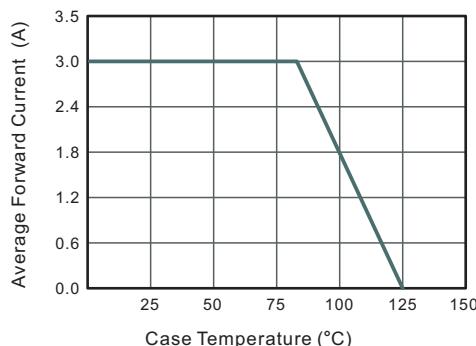
Ratings at 25 °C ambient temperature unless otherwise specified. Single phase, half wave, 60Hz resistive or inductive load, for capacitive load, derate by 20 %

Parameter	Symbols	SS32BF	SS34BF	SS36BF	SS38BF	SS310BF	SS312BF	SS315BF	SS320BF	Units								
Maximum Repetitive Peak Reverse Voltage	V <sub>RRM</sub>	20	40	60	80	100	120	150	200	V								
Maximum RMS voltage	V <sub>RMS</sub>	14	28	42	56	70	84	105	140	V								
Maximum DC Blocking Voltage	V <sub>DC</sub>	20	40	60	80	100	120	150	200	V								
Maximum Average Forward Rectified Current	I <sub>F(AV)</sub>	3.0								A								
Peak Forward Surge Current, 8.3ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I <sub>FSM</sub>	80								A								
Max Instantaneous Forward Voltage at 3 A	V <sub>F</sub>	0.55		0.70		0.85		0.95		V								
Maximum DC Reverse Current T <sub>a</sub> = 25°C at Rated DC Reverse Voltage T <sub>a</sub> = 100°C	I <sub>R</sub>	0.5 5		0.3 3						mA								
Typical Junction Capacitance <sup>(1)</sup>	C <sub>j</sub>	450		400						pF								
Typical Thermal Resistance <sup>(2)</sup>	R <sub>θJA</sub>	65								°C/W								
Operating Junction Temperature Range	T <sub>j</sub>	-55 ~ +125								°C								
Storage Temperature Range	T <sub>stg</sub>	-55 ~ +150								°C								

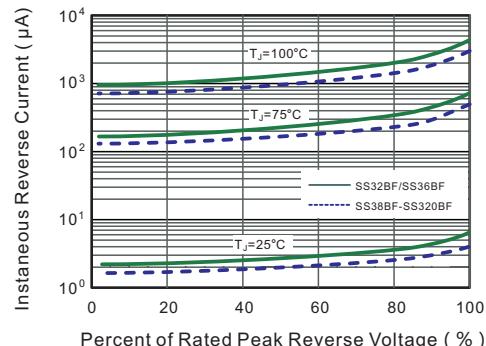
( 1 ) Measured at 1 MHz and applied reverse voltage of 4 V D.C

( 2 ) P.C.B. mounted with 2.0" X 2.0" (5 X 5 cm) copper pad areas.

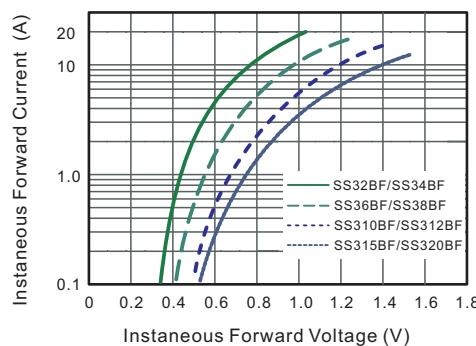
**Fig.1 Forward Current Derating Curve**



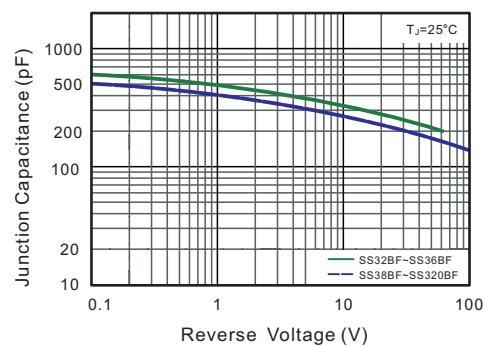
**Fig.2 Typical Reverse Characteristics**



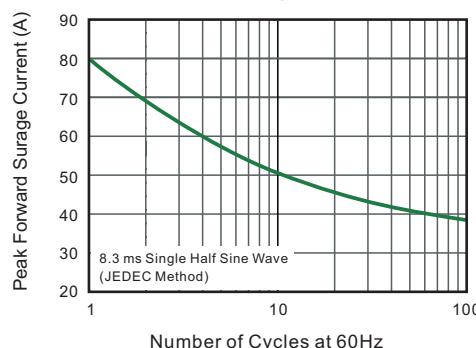
**Fig.3 Typical Forward Characteristic**



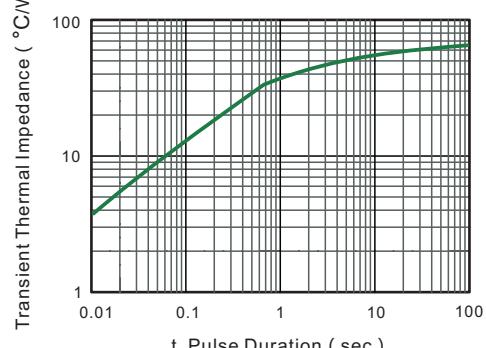
**Fig.4 Typical Junction Capacitance**



**Fig.5 Maximum Non-Repetitive Peak Forward Surge Current**



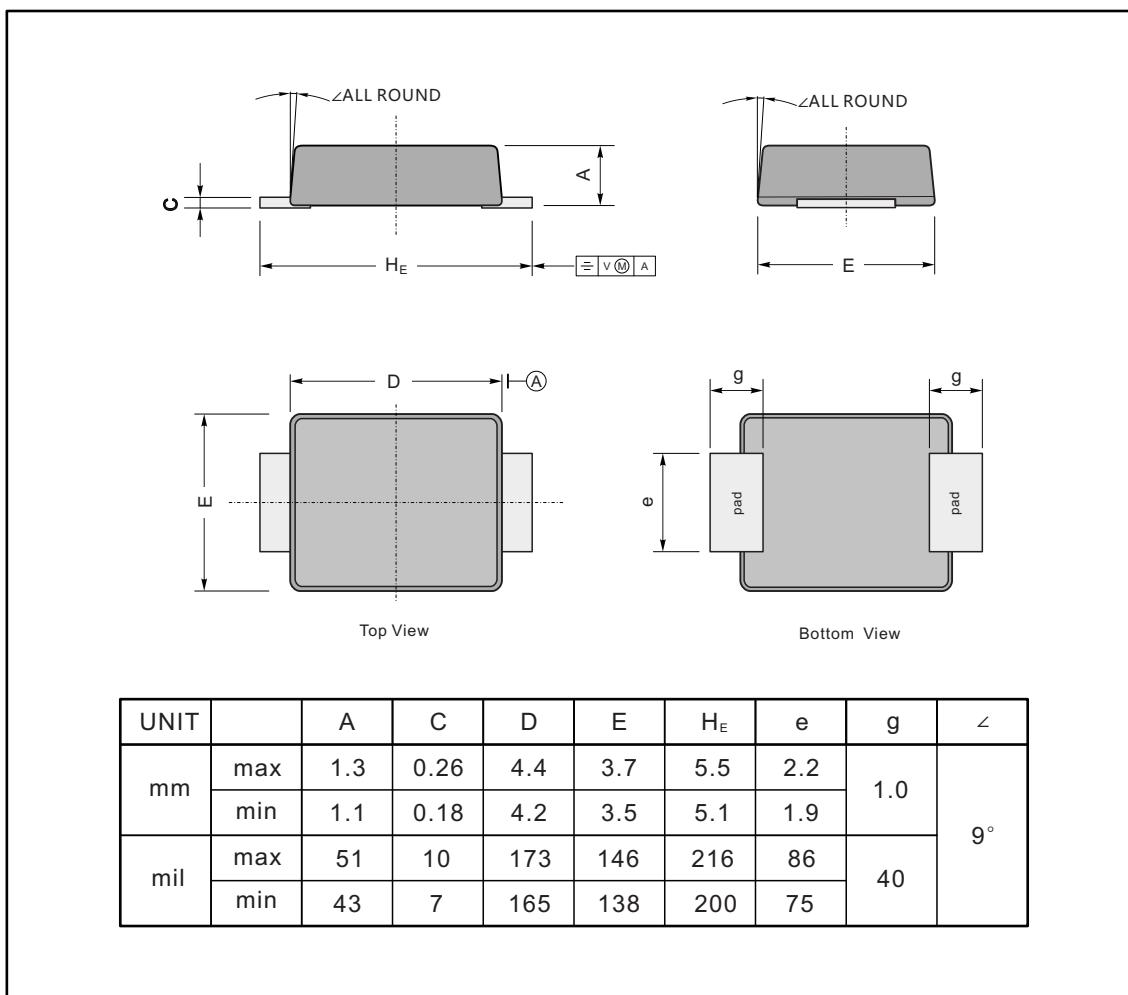
**Fig.6- Typical Transient Thermal Impedance**



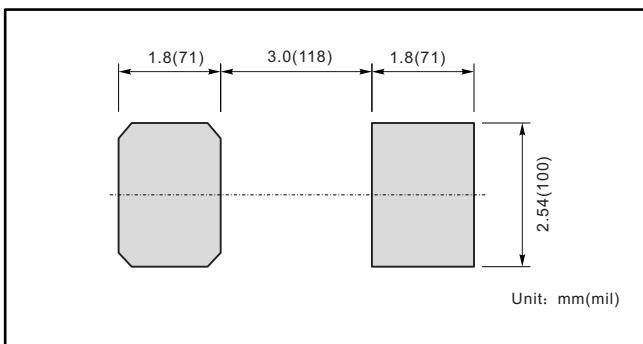
### PACKAGE OUTLINE

Plastic surface mounted package; 2 leads

SMBF



### The recommended mounting pad size



### Marking

Type number	Marking code
SS32BF	S32B
SS34BF	S34B
SS36BF	S36B
SS38BF	S38B
SS310BF	S310B
SS312BF	S312B
SS315BF	S315B
SS320BF	S320B